

PMP4408\_RevA\_Bom

Qty	Reference	Value	Description	Size	Part Number	MFR
1	D2	1N5408	DIODE, General Purpose, 600V, 3.0A	DO-201AD	1N5408	Fairchild
3	C18 C28-29	47uF	CAP ALUM 47UF 35V 20% RADIAL	6.3mm*11.2mm	EEU-FC1V470	Panasonic
2	B1-2	MMZ2012R102A	FERRITE CHIP 1000 OHM 500MA 0805	805	MMZ2012R102A	TDK
2	C7 C32	100nf	Capacitor, Ceramic, 100V, X7R, ±10%	603	C1608X7S2A104K	TDK
1	C3	100pf	Capacitor, Ceramic, 25V, X7R, ±10%	603	Std	muRata
5	C6 C8 C12 C31 C	10nf	Capacitor, Ceramic, 25V, X7R, ±10%	603	Std	muRata
1	C13	1nf	Capacitor, Ceramic, 25V, X7R, ±10%	603	Std	muRata
1	C24	22nf	Capacitor, Ceramic, 25V, X7R, ±10%	603	std	muRata
1	C4	22pf	Capacitor, Ceramic, 25V, X7R, ±10%	603	std	muRata
1	C34	470Pf	Capacitor, Ceramic, 25V, X7R, ±10%	603	Std	muRata
1	C14	NA	Capacitor, Ceramic, 25V, X7R, ±10%	603	std	muRata
1	C23	NA	Capacitor, Ceramic, 25V, X7R, ±10%	603	Std	muRata
3	C5 C10 C30	1uf	Capacitor, Ceramic, 25V, X7R, ±10%	805	Std	muRata
1	C26	22uf	CAP CER 22UF 25V 20% X5R 1206	1206	C3216X5R1E226M160AB	TDK
1	C21	22uF	CAP CER 22UF 6.3V X7R 1206	1206	std	muRata
1	C2	4.7nf	CAP CER 4700PF 630V 10% X7R 1206	1206	C3216X7R2J472K115AA	TDK
1	C15	NA				
1	C27	47uf	CAP CER 47UF 6.3V 20% X5R 1206	1206	C3216X5R0J476M160AC	TDK
1	C53	150uf	CAP ALUM 150UF 450V 20% SNAP	0.98 inch	EET-HC2W151CA	Panasonic
2	C19 C9	1000uF	CAP ALUM 1000UF 50V 20% RADIAL	12.5 x 25mm	ECA-1HM102	Panasonic
1	C17	NA				
1	C35	470uf	CAP ALUM 470UF 6.3V 20% RADIAL	6.3mm*9mm	6SEPC470MW+TSS	Panasonic
1	D3	BAS21-03W	Diode, High-Speed Switching, 250-mA, 200-V	SOD-323	BAS21-03W	Infineon
1	D8	NA	Diode, Schottky, 200-mA, 30-V	SOT23		Vishay-Liteon
1	D1	15V	DIODE ZENER 15V 500MW SOD-123	SOD123	Std	std
2	D9 D4	SS34B	Diode, Schottky Barrier, 3A, 40V	SMB	std	Std
1	D7	BU1508	Diode, IC BRIDGE RECT 15A 800V KBU	0.935 X 0.280 inch	BU1508	Vishay
1	L1	1.5mH	COMMON MODE CHOKE 1.5MH 2A T/H		PLA10AN1522R0R2B	MuRata
2	D5 D10	MBR20200CTE3/TU-1	DIODE SCHOTTKY 20A 200V TO220AB	TO-220	MBR20200CTE3/TU-ND	Microsemi
1	F1	2A/250V	FUSE 250V SLO-BLO 2AG 2A AXIAL	4.7mm*14.48mm	0230002.DRT1P	Littelfuse / Wickmann
1	E3	ERZ-V14D471	SUR ABSORBER 14MM 470V 4500A ZNR	0.650 x 0.650 inch		Panasonic
1	NTC1	3R	CURRENT LIMITER		NTPAN3R0LDKBO	MuRata
1	M1-2					Customer provide
1	Q2	SPP20N60C3	MOSFET N-CH 650V 4.5A TO-251	TO-220AB	SPP20N60C3	Infineon
1	C1	0.1uF	CAP .1UF 275VAC INTER SUPP X2	0.689 x 0.217 inch	R46KI3100DQM1K	Kemet
1	H1	28600-3	Heatsink, Custom	1.025 x 0.963 inch		TI
1	L4	47uH	Inductor, SMT, 1.3A, 195milliohm		CDRH8D28NP-470NC	sumida
1	L2	27uH	Inductor, SMT, 2.5A, 67milliohm		CDRH8D38NP-150NC	sumida
1	U2	LM5023MM	IC, AC-DC Quasi-Resonant Current Mode PWM Controller		LM5023MM	TI
1	U4	FOD817CS	OPTOCOUPLER PHOTOTRANS OUT 4-SMD	SMD	FOD817CS	Fairchild
2	C16 C22	2200pF	CAP CER 2200PF 250VAC 20% RADIAL		DE1E3KX222MN5AA01	Murata
1	T1	750342275	ERL35 Transformer		750342275	Würth
2	R37 R40	10K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1	R17	10k	Resistor, Chip, 1/10W, 1%	603	Std	Std
1	R38	22K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1	R16	86k	Resistor, Chip, 1/10W, 1%	603	Std	Std
2	R3 R6	NA	Resistor, Chip, 1/10W, 1%	603	Std	Std

1 R14	0	Resistor, Chip, 1/10W, 1%	603	Std	Std
2 R19 R22	100K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R25	10K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R23	13K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R21	16K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R24	180K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R15	1K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R8	4.3K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R12	68K	Resistor, Chip, 1/10W, 1%	603	Std	Std
2 R2 R20	82K	Resistor, Chip, 1/10W, 1%	603	Std	Std
1 R13	10M	Resistor, Chip, 1/8W, 1%	805	Std	Std
1 R11	22	Resistor, Chip, 1/8W, 1%	805	Std	Std
2 R9-10	100k	Resistor, Metal Film, 1/4 watt, ± 1%	1206	Std	Std
1 R5	10k	Resistor, Metal Film, 1/4 watt, ± 1%	1206	Std	Std
3 R7 R26-27	1M	Resistor, Metal Film, 1/4 watt, ± 1%	1206	Std	Std
2 R1 R29	300K	Resistor, Metal Film, 1/4 watt, ± 1%	1206	Std	Std
1 R28	33	Resistor, Metal Film, 1/4 watt, ± 1%	1206	Std	Std
1 R18	NA	Resistor, Metal Film, 1/4 watt, ± 1%	1206	Std	Std
1 R4	0.1	Resistor, Chip, 1W, 1%	2512	Std	STD
1 U5	TL431AIDBZ	IC, Precision Adjustable Shunt Regulator	SOT23-3	TL431AIDBZ	TI
2 U1 U6	TPS5402	IC, Economy Primary-Side Controller, xx-V Startup	DGK8	TPS5402	TI
1 Q1	BSS126	MOSFET, Nch, 600V, 7 mA, 700 Ohm		BSS126	Infineon
1 Q3	NA	Bipolar, NPN, xx-V, yy-mA, zz-W	SOT23		On Semi

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